

L Number	Hits	Search Text	DB	Time stamp
1	1449	29/599.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/01 08:02
-	117	(ceramic adj heater) and (ceramic adj substrate) and disc	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 21:34
-	103	(ceramic adj heater) and (ceramic adj substrate) and disc and (resistance adj heating element)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:37
-	13	(ceramic adj heater) and (ceramic adj substrate) and disc and (resistance adj heating element) and (maximum adj pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:44
-	13	(ceramic adj heater) and (maximum adj pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:44
-	22	(ceramic adj substrate) and (maximum adj pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:50
-	0	(nonoxide adj ceramic) and (maximum adj pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:50
-	10	(non adj oxide adj ceramic) and (maximum adj pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:51
-	50	(non adj oxide adj ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:05
-	0	(non adj oxide adj ceramic) adj (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:51
-	4	(non adj oxide adj ceramic) with (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:53
-	7	(non adj oxide adj ceramic) same (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:54
-	0	(oxide adj free adj ceramic) same (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:56
-	0	(ceramic adj free adj oxide) same (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:55

-	0	(ceramic adj free adj oxide) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:55
-	0	(oxide adj free adj ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:59
-	0	(absence adj oxide adj ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 17:59
-	0	(oxide adj absent adj ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:00
-	0	(oxide adj removed adj ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:00
-	15	(oxide with removed with ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:03
-	0	(oxide with deleted with ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:03
-	68	((non adj oxide) with ceramic) and (pore adj diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:15
-	15	((non adj oxide) with ceramic) and (maximum adj (pore adj diameter))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 18:15
-	481	(ceramic adj heater) and disc	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 21:41
-	34	(ceramic adj heater) and semiconductor and examining	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 21:42
-	303	(ceramic adj heater) and semiconductor and producing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 21:42
-	73	(ceramic adj heater) and semiconductor and testing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/22 21:43
-	292	(ceramic adj heater) and semiconductor and measuring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:18

-	1582	219/544.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:28
-	212	219/444.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:31
-	1940	219/553.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:34
-	1730	118/724.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:47
-	2181	118/725.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:53
-	48	29/\$.ccls. and sintering and (raw adj material adj powder)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:56
-	35	29/\$.ccls. and sintering and (raw adj material adj powder) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:56
-	1024	29/\$.ccls. and sintering and (powder) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 12:58
-	14	29/\$.ccls. and sintering and (raw adj powder) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 13:00
-	47	29/\$.ccls. and (ceramic adj heater)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/24 13:01
-	1951	29/\$.ccls. and (ceramic adj substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/01 08:00